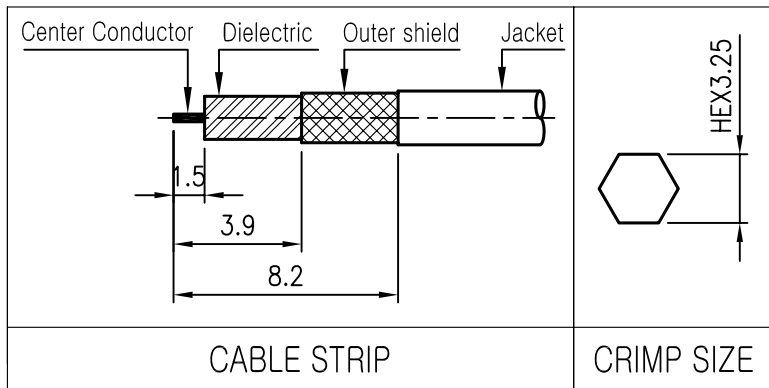
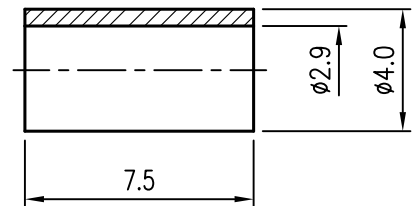
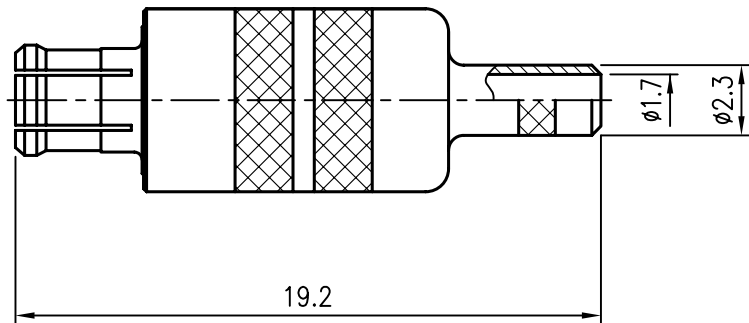


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration			1996.04.15.
1	PIN Solder부 형상 변경(Push 커팅 -> Solder)	I.C.KIM		2020.12.15.



△1	5	JACK	1	BeCu C17300	Gold Plate	DJA00004-5/1
	4	INSULATOR	1	TEFLON		DIN00073-N/1
	3	FERRULE	1	MBsBD C3604BD-F	Gold Plate	DFE00020-5/1
	2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT00062-5/2 DCT00062-5/1
	1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD00092-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.3	DATE 2020. 12. 15.		KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY			
MATERIAL		CHECKED BY		TITLE MCX75 CABLE PS RG179	
		DRAWN BY	I.C.KIM		
FINISH		SCALE 3/1	UNIT mm	 A4	DWG NO. CN00055-7/1
				REVISION 1	SHEET 1 of 1